

MOSFET

OptiMOS[™] 6 Power-Transistor, 135 V

Features

- N-channel, normal level
- Very low on-resistance R_{DS(on)}
- Excellent gate charge x R_{DS(on)} product (FOM)
 Very low reverse recovery charge (Q_{rr})
- 100% avalanche tested
- 175°C operating temperature
- Optimized for motor drives and battery powered applications
 Pb-free lead plating; RoHS compliant
 Halogen-free according to IEC61249-2-21

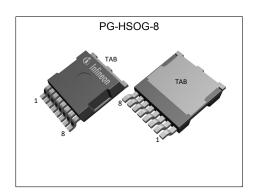
- MSL 1 classified according to J-STD-020

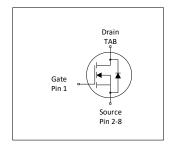


Fully qualified according to JEDEC for Industrial Applications

Table 1 **Key Performance Parameters**

Table 1 Roy 1 of formation 1 aramotors							
Parameter	Value	Unit					
$V_{ t DS}$	135	V					
R _{DS(on),max}	2.0	mΩ					
I _D	297	А					
Qoss	274	nC					
Q _G	159	nC					
Q _{rr} (500 A/µs)	154	nC					











Type / Ordering Code	Package	Marking	Related Links
IPTG020N13NM6	PG-HSOG-8	020N13N6	-

OptiMOS[™] 6 Power-Transistor, 135 V IPTG020N13NM6



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OptiMOS[™] 6 Power-Transistor, 135 V IPTG020N13NM6



1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 Maximum ratings

Davomatar	Cumbal		Value	s		Note / Test Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Continuous drain current ¹⁾	I _D	- - -	- - -	297 210 196 29	A	$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =8 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =10 V, $T_{\rm A}$ =25 °C, $R_{\rm THJA}$ =40 °C/W ²⁾	
Pulsed drain current ³⁾	I _{D,pulse}	-	-	1188	Α	T _C =25 °C	
Avalanche current, single pulse ⁴⁾	I _{AS}	-	-	142	Α	T _C =25 °C	
Avalanche energy, single pulse ⁴⁾	E _{AS}	-	-	832	mJ	$I_{\rm D}$ =69 A, $R_{\rm GS}$ =25 Ω	
Gate source voltage	V _{GS}	-20	-	20	V	-	
Power dissipation	P _{tot}	-	-	395 3.8	W	T _C =25 °C T _A =25 °C, R _{THJA} =40 °C/W ²⁾	
Operating and storage temperature	T _j , T _{stg}	-55	-	175	°C	-	

2 Thermal characteristics

Table 3 Thermal characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition	
	Syllibol	Min.	Тур.	Max.	Offic	Note / Test Condition	
Thermal resistance, junction - case	R _{thJC}	-	-	0.4	°C/W	-	
Thermal resistance, junction - ambient, 6 cm² cooling area²)	R _{thJA}	-	-	40	°C/W	-	
Thermal resistance, junction - ambient, minimal footprint	R_{thJA}	-	-	62	°C/W	-	

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions.

2) Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 µm thick) copper area for drain

connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed information.

4) See Diagram 13 for more detailed information.

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3 Electrical characteristics at T_j =25 °C, unless otherwise specified

Table 4 **Static characteristics**

Damana dan	0		Value	s		Note / Took Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Drain-source breakdown voltage	V _{(BR)DSS}	135	-	-	V	V _{GS} =0 V, I _D =1 mA	
Gate threshold voltage	V _{GS(th)}	2.5	3	3.5	V	V _{DS} =V _{GS} , I _D =275 μA	
Zero gate voltage drain current	I _{DSS}	-	1 10	10 100	μΑ	V _{DS} =108 V, V _{GS} =0 V, T _j =25 °C V _{DS} =108 V, V _{GS} =0 V, T _j =125 °C	
Gate-source leakage current	I _{GSS}	-	10	100	nA	V _{GS} =20 V, V _{DS} =0 V	
Drain-source on-state resistance	R _{DS(on)}	- - -	1.7 1.8 1.9	1.95 2.0 2.3	mΩ	V _{GS} =15 V, I _D =142 A V _{GS} =10 V, I _D =142 A V _{GS} =8 V, I _D =71 A	
Gate resistance ¹⁾	R _G	-	1.1	1.7	Ω	-	
Transconductance ¹⁾	g fs	140	280	-	S	<i>V</i> _{DS} ≥2 <i>I</i> _D <i>R</i> _{DS(on)max} , <i>I</i> _D =142 A	

Table 5 **Dynamic characteristics**

Parameter	O. mak a l		Values			Nata / Taat Canditian
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance ¹⁾	C _{iss}	-	11000	14000	pF	V _{GS} =0 V, V _{DS} =68 V, <i>f</i> =1 MHz
Output capacitance ¹⁾	Coss	-	2200	2900	pF	V _{GS} =0 V, V _{DS} =68 V, <i>f</i> =1 MHz
Reverse transfer capacitance ¹⁾	C _{rss}	-	28	49	pF	V _{GS} =0 V, V _{DS} =68 V, <i>f</i> =1 MHz
Turn-on delay time	t _{d(on)}	-	21	-	ns	$V_{\rm DD}$ =68 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =71 A, $R_{\rm G,ext}$ =1.6 Ω
Rise time	t _r	-	17	-	ns	$V_{\rm DD}$ =68 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =71 A, $R_{\rm G,ext}$ =1.6 Ω
Turn-off delay time	$t_{\sf d(off)}$	-	48	-	ns	$V_{\rm DD}$ =68 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =71 A, $R_{\rm G,ext}$ =1.6 Ω
Fall time	t _f	-	22	-	ns	$V_{\rm DD}$ =68 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =71 A, $R_{\rm G,ext}$ =1.6 Ω

Gate charge characteristics²⁾ Table 6

Dovometer	Complete	Values			11::4	Note / Took Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge ¹⁾	Q _{gs}	-	49	64	nC	$V_{\rm DD}$ =68 V, $I_{\rm D}$ =71 A, $V_{\rm GS}$ =0 to 10 V
Gate charge at threshold	$Q_{g(th)}$	-	33	-	nC	$V_{\rm DD}$ =68 V, $I_{\rm D}$ =71 A, $V_{\rm GS}$ =0 to 10 V
Gate to drain charge ¹⁾	Q_{gd}	-	30	45	nC	$V_{\rm DD}$ =68 V, $I_{\rm D}$ =71 A, $V_{\rm GS}$ =0 to 10 V
Switching charge	Q _{sw}	-	47	-	nC	$V_{\rm DD}$ =68 V, $I_{\rm D}$ =71 A, $V_{\rm GS}$ =0 to 10 V
Gate charge total ¹⁾	Q g	-	159	207	nC	$V_{\rm DD}$ =68 V, $I_{\rm D}$ =71 A, $V_{\rm GS}$ =0 to 10 V
Gate plateau voltage	V _{plateau}	-	4.5	-	V	$V_{\rm DD}$ =68 V, $I_{\rm D}$ =71 A, $V_{\rm GS}$ =0 to 10 V
Gate charge total, sync. FET	Q _{g(sync)}	-	145	-	nC	V _{DS} =0.1 V, V _{GS} =0 to 10 V
Output charge ¹⁾	Qoss	_	274	356	nC	V _{DS} =68 V, V _{GS} =0 V

 $^{^{1)}}$ Defined by design. Not subject to production test. $^{2)}$ See "Gate charge waveforms" for parameter definition

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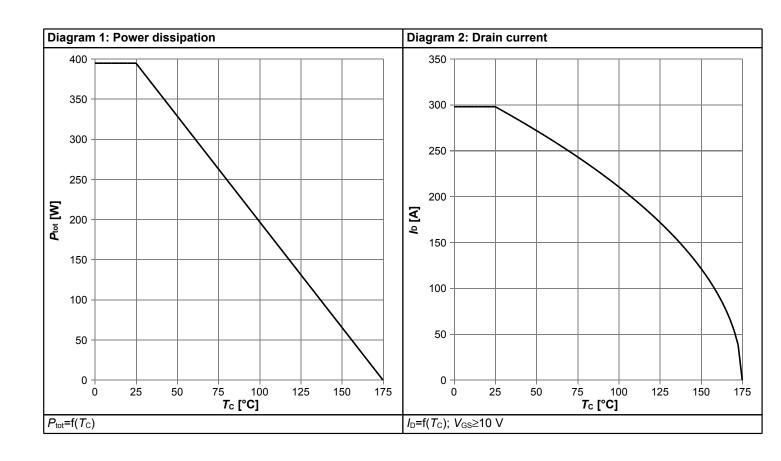


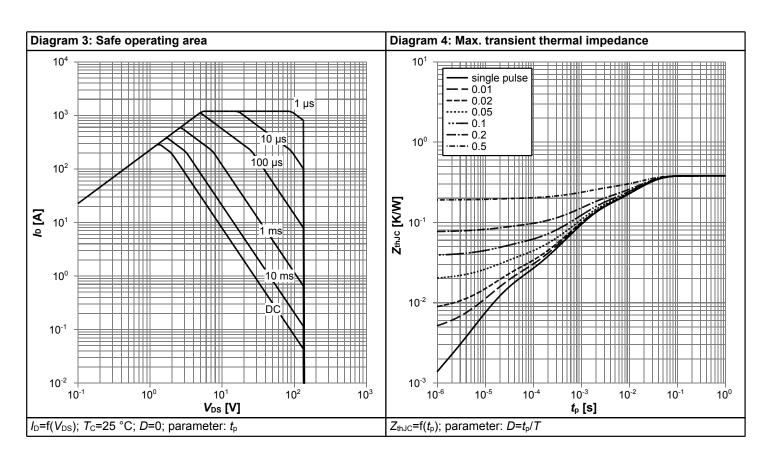
Table 7 Reverse diode

Parameter	Cumbal		Values			Nets / Test Osmalities
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode continuous forward current	Is	-	-	297	Α	T _C =25 °C
Diode pulse current	I _{S,pulse}	-	-	1188	Α	T _C =25 °C
Diode forward voltage	V _{SD}	-	0.87	1	V	V _{GS} =0 V, I _F =142 A, T _j =25 °C
Reverse recovery time ¹⁾	t _{rr}	-	36	72	ns	V _R =68 V, I _F =71 A, d <i>i</i> _F /d <i>t</i> =500 A/μs
Reverse recovery charge ¹⁾	Qrr	-	154	308	nC	V _R =68 V, I _F =71 A, d <i>i</i> _F /d <i>t</i> =500 A/μs

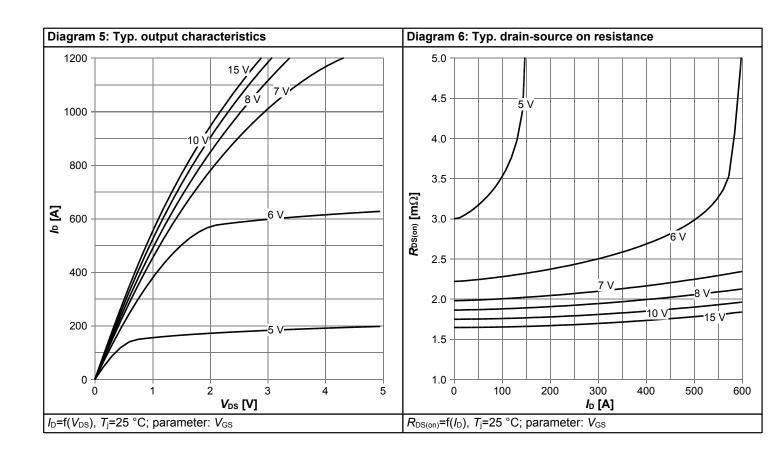


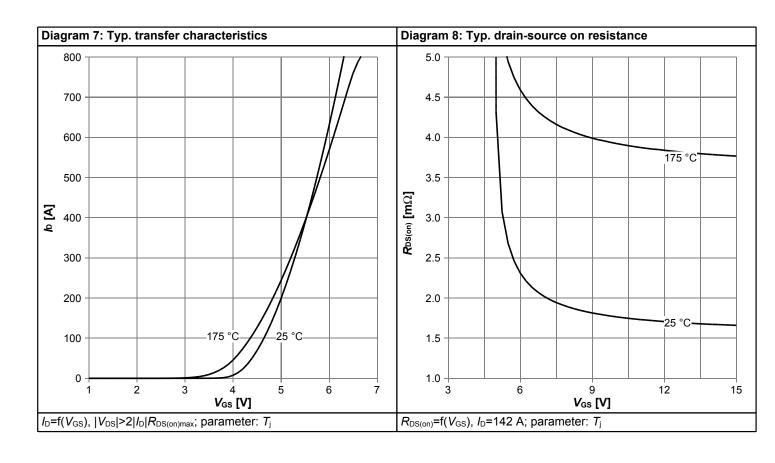
4 Electrical characteristics diagrams



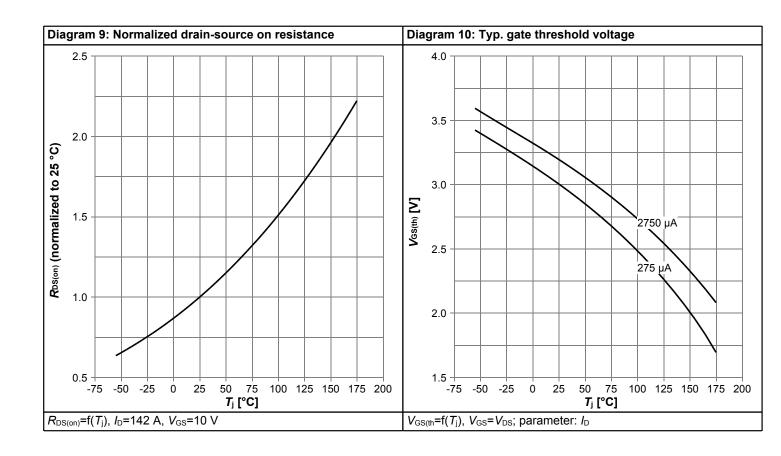


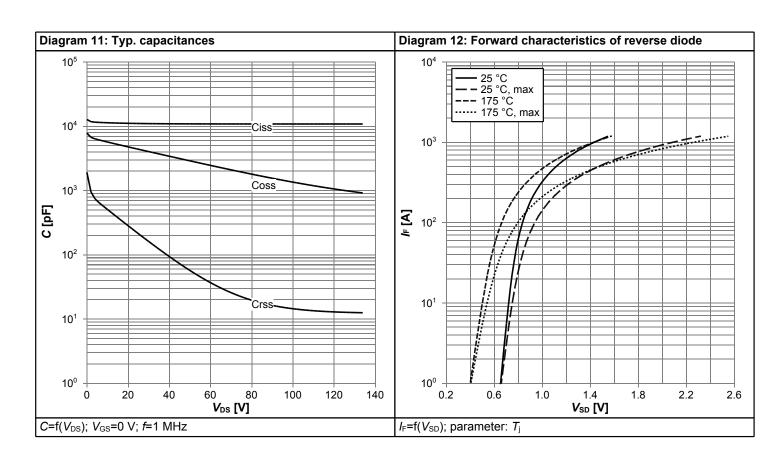




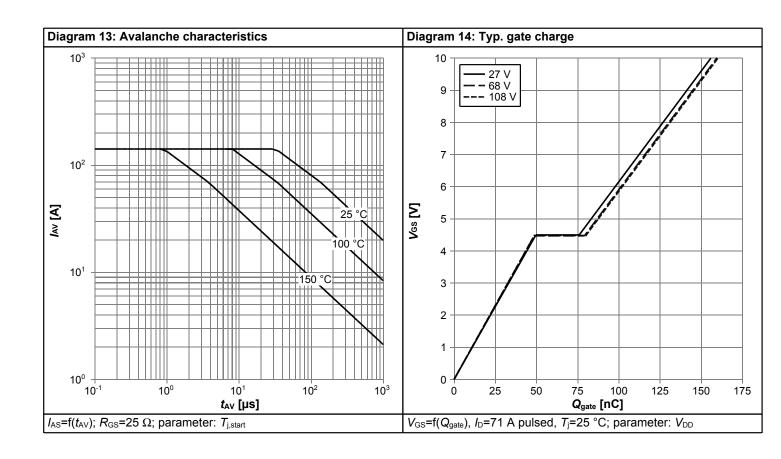


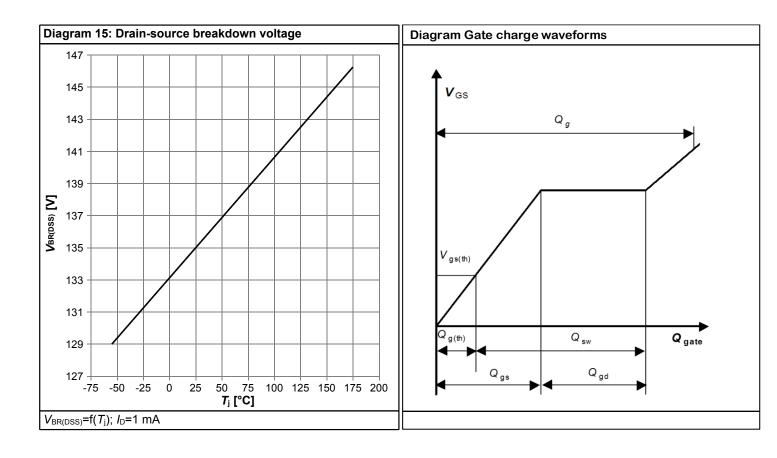






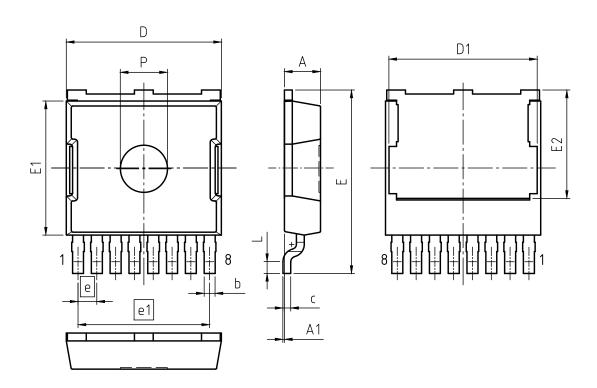








5 Package Outlines



PACKAGE - GROUP NUMBER:	PG-HSC	PG-HSOG-8-U01				
REVISION: 01	DATE:	08.02.2021				
DIMENSIONS	MILLIM	IETERS				
DIMENSIONS	MIN.	MAX.				
Α	2.20	2.40				
A1	0.00	0.10				
b	0.60	0.80				
С	0.40	0.60				
D	9.70	10.10				
D1	9.36	9.56				
E	11.50	11.90				
E1	8.45	8.75				
E2	6.81	7.01				
е	1.	1.20				
e1	8.40					
L	0.66	0.86				
Р	2.90	3.10				

Figure 1 Outline PG-HSOG-8, dimensions in mm

OptiMOS[™] 6 Power-Transistor, 135 V





Revision History

IPTG020N13NM6

Revision: 2023-10-16, Rev. 2.0

Previous Revision

Revision	Date	Subjects (major changes since last revision)			
2.0	2023-10-16	Release of final version			

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